# DATA SHEET



# MOS FIELD EFFECT TRANSISTOR 2SK2482

# **SWITCHING** N-CHANNEL POWER MOS FET **INDUSTRIAL USE**

### DESCRIPTION

The 2SK2482 is N-Channel MOS Field Effect Transistor designed for high voltage switching applications.

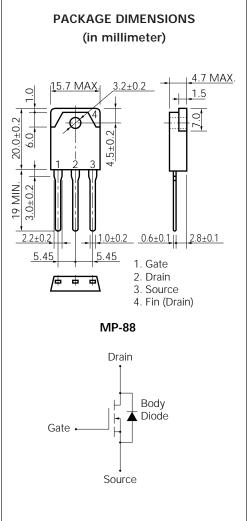
#### **FEATURES**

- Low On-Resistance
- RDS (on) =  $4.0 \Omega$  (VGS = 10 V, ID = 3.0 A)
- Low Ciss Ciss = 900 pF TYP.
- High Avalanche Capability Ratings

#### ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Drain to Source Voltage	VDSS	900	V
Gate to Source Voltage	Vgss	±30	V
Drain Current (DC)	D (DC)	±5.0	А
Drain Current (pulse)*	D (pulse)	) ±12	А
Total Power Dissipation (Tc = 25 °C)	Рт1	100	W
Total Power Dissipation (TA = 25 °C)	Рт2	3.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg -	-55 to +150	°C
Single Avalanche Current**	las	5.0	А
Single Avalanche Energy**	Eas	73.5	mJ
* PW $\leq$ 10 $\mu$ s, Duty Cycle $\leq$ 1 %			

\*\* Starting T<sub>ch</sub> = 25 °C, R<sub>G</sub> = 25  $\Omega$ , V<sub>GS</sub> = 20 V  $\rightarrow$  0

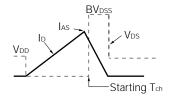


ELECTRICAL	CHARACTERISTICS	(TA = 25 °C)
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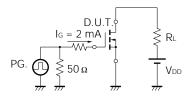
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain to Source On-Resistance	RDS (on)		3.2	4.0	Ω	Vgs = 10 V, Id = 3.0 A
Gate to Source Cutoff Voltage	VGS (off)	2.5		3.5	V	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA
Forward Transfer Admittance	<b>y</b> fs	1.0			S	Vds = 20 V, Id = 3.0 A
Drain Leakage Current	IDSS			100	μA	V <sub>DS</sub> = V <sub>DSS</sub> , V <sub>GS</sub> = 0
Gate to Source Leakage Current	lgss			±100	nA	$V_{GS} = \pm 30 V$ , $V_{DS} = 0$
Input Capacitance	Ciss		900		pF	V <sub>DS</sub> = 10 V
Output Capacitance	Coss		130		pF	V <sub>GS</sub> = 0
Reverse Transfer Capacitance	Crss		25		pF	f = 1 MHz
Turn-On Delay Time	td (on)		17		ns	ID = 3.0 A
Rise Time	tr		8		ns	V <sub>GS</sub> = 10 V
Turn-Off Delay Time	td (off)		60		ns	Vdd = 150 V
Fall Time	tr		10		ns	$R_G = 10 \Omega$
Total Gate Charge	QG		30		nC	ID = 5.0 A
Gate to Source Charge	Qgs		5		nC	V <sub>DD</sub> = 450 V
Gate to Drain Charge	Qgd		13		nC	Vgs = 10 V
Body Diode Forward Voltage	VF (S-D)		1.0		V	IF = 5.0 A, VGS = 0
Reverse Recovery Time	trr		780		ns	IF = 5.0 A, VGS = 0
Reverse Recovery Charge	Qrr		4.2		μC	di/dt = 50 A/µs

#### Test Circuit 1 Avalanche Capability

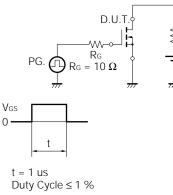
#### D.U.T $R_G = 25 \Omega$ h PG V<sub>GS</sub> = 20 - 0 V 50 Ω Vdd



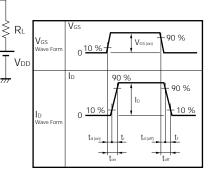
Test Circuit 3 Gate Charge



Test Circuit 2 Switching Time

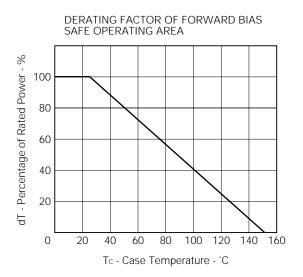


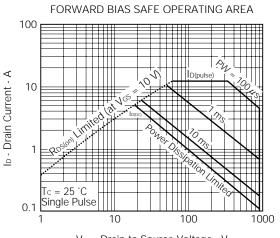
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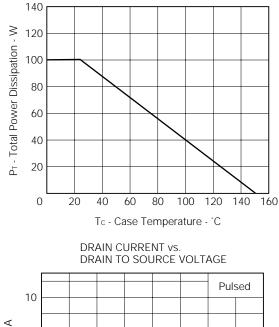
The application circuits and their parameters are for references only and are not intended for use in actual design-in's.



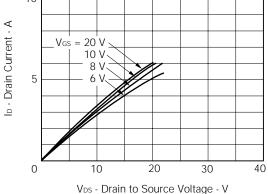




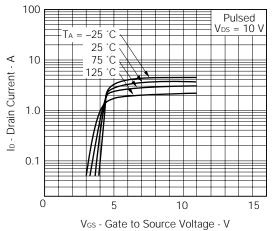
 $V_{\text{DS}}$  - Drain to Source Voltage - V

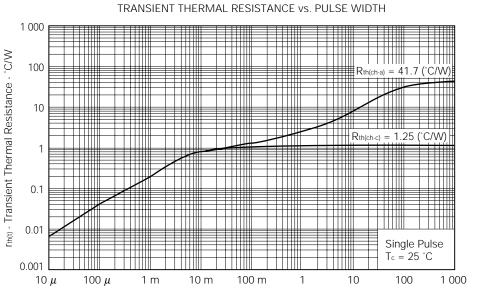


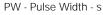
TOTAL POWER DISSIPATION vs. CASE TEMPERATURE



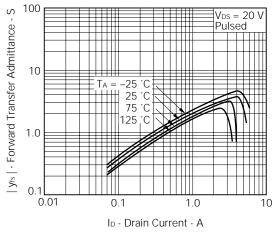


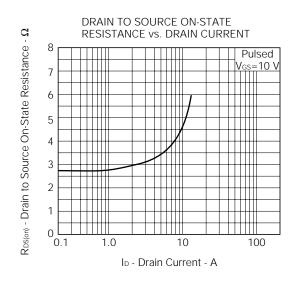




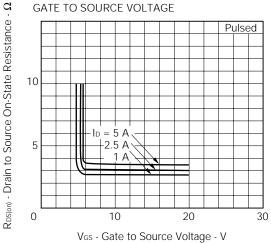




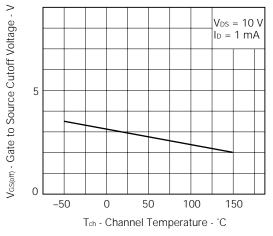




DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



GATE TO SOURCE CUTOFF VOLTAGE vs. CHANNEL TEMPERATURE



Pulsed

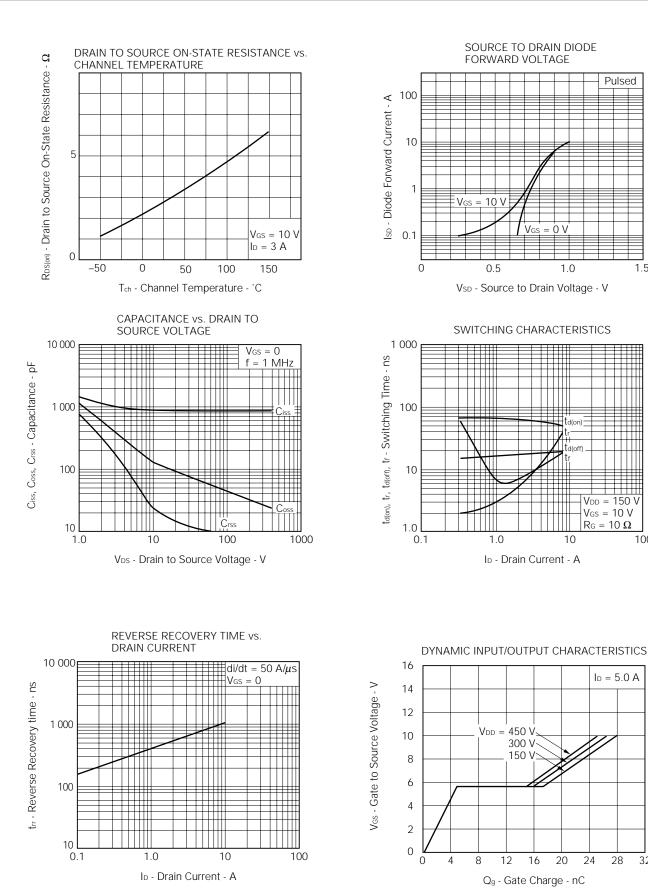
1.5

100

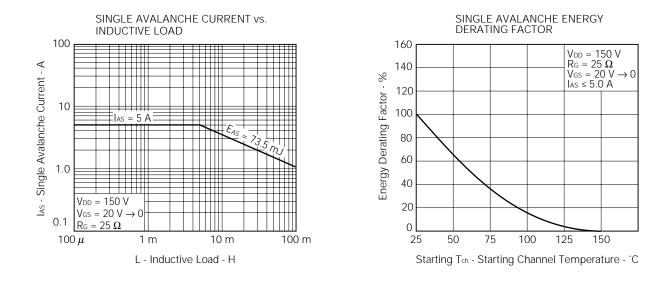
 $I_{D} = 5.0 \text{ A}$ 

28

32



5



## REFERENCE

Document Name	Document No.
NEC semiconductor device reliability/quality control system.	TEI-1202
Quality grade on NEC semiconductor devices.	IEI-1209
Semiconductor device mounting technology manual.	IEI-1207
Semiconductor device package manual.	IEI-1213
Guide to quality assurance for semiconductor devices.	MEI-1202
Semiconductor selection guide.	MF-1134
Power MOS FET features and application switching power supply.	TEA-1034
Application circuits using Power MOS FET.	TEA-1035
Safe operating area of Power MOS FET.	TEA-1037

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Anti-radioactive design is not implemented in this product.

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